# 18–40 GHz GaAs MMIC High Isolation SPST Reflective PIN Switch

# **III Alpha**

#### AP640R1-00

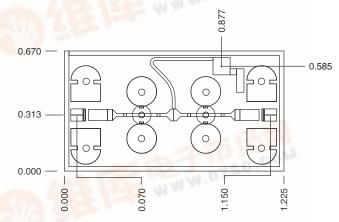
#### **Features**

- Broad Bandwidth
- Low Loss, < 1.3 dB
- High Isolation, > 37 dB
- Excellent Return Loss, < -13 dB</p>
- Fast Switching Speed, 4 ns
- High Power Handling, 37 dBm Peak, 33 dBm CW

#### Description

Alpha's high isolation, single pole, single throw PIN diode switch is a robust, high performance switch. It is ideal for low loss, high isolation applications, particularly where broad bandwidths and high power handling is required. The chip uses Alpha's proven PIN diode technology, and is based upon MBE layers for the highest uniformity and repeatability. The diodes employ surface passivation to ensure a rugged, reliable part with through-substrate via holes and gold-based backside metallization to facilitate an epoxy die attach process. The GaAs MMIC employs two shunt PIN diodes and an on-chip bias network. Chips are measured on a 100% basis at 24, 28, 31 and 35 GHz for insertion loss, isolation, input and output return losses, and also at DC for diode breakdown voltage and turn on voltage.

#### **Chip Outline**



Dimensions indicated in mm. All pads are  $\geq$  0.07 mm wide. Chip thickness = 0.1 mm.

#### **Absolute Maximum Ratings**

Characteristic	Value		
Operating Temperature	-55°C to +125°C		
Storage Temperature	-65°C to +150°C		
DC Reverse Bias	Bias -70 V (-20 mA)		
DC Forward Bias	ard Bias +1.3 V (100 mA)		
P <sub>IN</sub>	10 W		

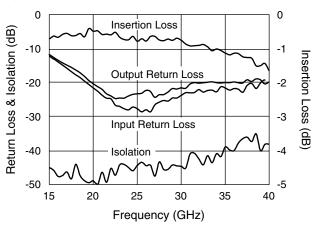
### **Electrical Specifications at 25°C**

Symbol	Condition	Min.	Typ. <sup>2</sup>	Max.	Unit
IL	F = 18, 21, 24, 28, 31, 35 GHz	-	1.0	1.3	dB
	F = 38, 40 GHz	MAL.	1.3	1.9	dB
ISO	F = 18, 21, 24, 28, 31, 35 GHz	37	42		dB
	F = 38, 40 GHz	33	36		dB
RL	F = 18, 21 GHz		14	12	dB
	F = 24, 28, 31, 35, 38, 40 GHz		24	15	dB
RLO	F = 18, 21 GHz		14	12	dB
	F = 24, 28, 31, 35, 38, 40 GHz		22	13	dB
I <sub>DD</sub>	V = -50 V		2	20	μΑ
			4		ns
P <sub>1 dB</sub>	F = 35 GHz		33		dBm
	IL ISO RL <sub>I</sub> RL <sub>O</sub>	IL F = 18, 21, 24, 28, 31, 35 GHz F = 38, 40 GHz  ISO F = 18, 21, 24, 28, 31, 35 GHz F = 38, 40 GHz  F = 18, 21 GHz F = 24, 28, 31, 35, 38, 40 GHz  RLO F = 18, 21 GHz F = 24, 28, 31, 35, 38, 40 GHz  V = -50 V	IL F = 18, 21, 24, 28, 31, 35 GHz F = 38, 40 GHz  ISO F = 18, 21, 24, 28, 31, 35 GHz 37 F = 38, 40 GHz 33  RL <sub>I</sub> F = 18, 21 GHz F = 24, 28, 31, 35, 38, 40 GHz  RL <sub>O</sub> F = 18, 21 GHz F = 24, 28, 31, 35, 38, 40 GHz  IDD V = -50 V	IL F = 18, 21, 24, 28, 31, 35 GHz 1.0 F = 38, 40 GHz 1.3 ISO F = 18, 21, 24, 28, 31, 35 GHz 37 42 F = 38, 40 GHz 33 36 RL <sub>I</sub> F = 18, 21 GHz 14 F = 24, 28, 31, 35, 38, 40 GHz 24 RL <sub>O</sub> F = 18, 21 GHz 14 F = 24, 28, 31, 35, 38, 40 GHz 22 I <sub>DD</sub> V = -50 V 2	IL F = 18, 21, 24, 28, 31, 35 GHz 1.0 1.3 F = 38, 40 GHz 1.3 1.9  ISO F = 18, 21, 24, 28, 31, 35 GHz 37 42 F = 38, 40 GHz 33 36  RL <sub>I</sub> F = 18, 21 GHz 14 12 F = 24, 28, 31, 35, 38, 40 GHz 24 15  RL <sub>O</sub> F = 18, 21 GHz 14 12 F = 24, 28, 31, 35, 38, 40 GHz 22 13  I <sub>DD</sub> V = -50 V 2 2 20

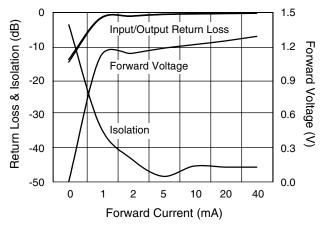
Not measured on a 100% basis.

Typical represents the median parameter value across the specified frequency range for the median chip.

## **Typical Performance Data**

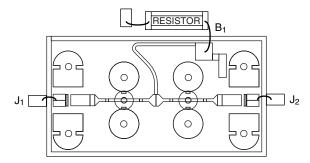


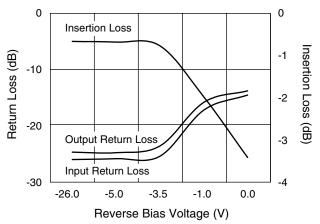
Performance vs. Frequency Bias Conditions:  $I_F = 20 \text{ mA}$ ,  $V_R = -3.5 \text{ V}$ 



Performance vs. DC Bias F = 28 GHz

#### **Bias Arrangement**





Performance vs. DC Bias F = 28 GHz

#### **Truth Table**

B <sub>1</sub>	J <sub>1</sub> –J <sub>2</sub>
+20 mA	Isolation
-5 V	Insertion Loss

#### **Circuit Schematic**

